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(71) Applicant: NEC CORPORATION
Tokyo (JP)

(72) Inventors:
• Ishizaka, Masashige
Minato-ku, Tokyo (JP)

• Yamazaki, Hiroyuki
Minato-ku, Tokyo (JP)

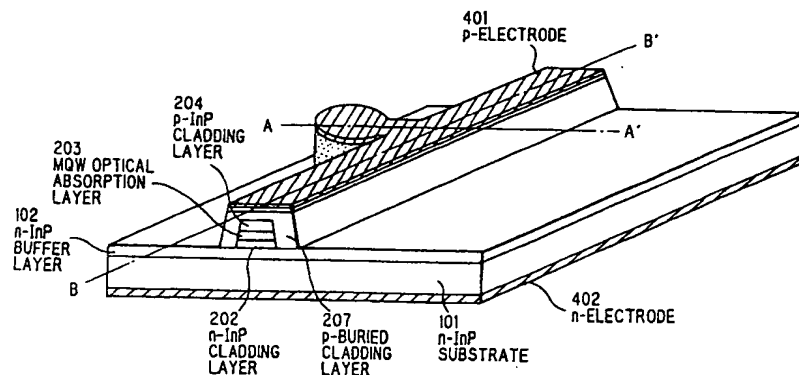
(74) Representative:
Glawe, Delfs, Moll & Partner
Patentanwälte
Postfach 26 01 62
80058 München (DE)

(54) Semiconductor optical modulator and method for making the same

(57) Disclosed is an electroabsorption-type optical modulator, which has: a semiconductor substrate; and a semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer which are layered in this order on the semiconductor substrate; wherein the absorption of a light wave supplied to an end of the semiconductor optical absorption layer is controlled by changing an intensity of electric field applied to the semiconductor optical absorption layer; and the semiconductor optical absorption layer has a region with absorption-edge wavelength shorter than that of the other region of the semiconductor opti-

cal absorption layer and a voltage corresponding an external electrical signal is simultaneously applied to both the regions of the semiconductor optical absorption layer, so that, to an incident light, a refractive index of the semiconductor optical absorption layer is decreased and an absorption coefficient of the semiconductor optical absorption layer is increased when an intensity of electric field applied to the semiconductor optical absorption layer corresponding to the external electrical signal is increased.

FIG. 4



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Description

FIELD OF THE INVENTION

5 This invention relates to a semiconductor optical modulator, and more particularly to, an electroabsorption-type optical modulator in which the absorption of a light wave supplied is controlled by changing an intensity of electric field applied to a semiconductor optical absorption layer, and relates to a method for making the same.

BACKGROUND OF THE INVENTION

10 Recently, with the development of high-speed and long-distance optical communication systems, there occurs a problem in conventional direct modulation manners with semiconductor lasers. Namely, in the semiconductor laser direct modulation manners, wavelength chirping occurs when the modulation is conducted, thereby the waveform after transmitting through an optical fiber is deteriorated. This phenomenon is amplified with an increase in signal modulation frequency or transmission distance. Especially, in a system that uses a conventional 1.3 μm zero-dispersion fiber, this problem is serious. Even if a light source with a wavelength band of 1.55 μm that has a small fiber propagation loss is used to increase the transmission distance, the transmission distance is limited by a dispersion limitation due to the chirping.

20 This problem can be solved by an external modulation manner that modulates light emitted from a semiconductor laser by an external optical modulator other than the semiconductor laser while keeping the semiconductor laser emitting the light with a constant optical output. Therefore, external optical modulators has been increasingly developed. The external optical modulators can be composed of dielectric materials such as LiNbO₃ or semiconductor materials such as InP, GaAs. In particular, semiconductor optical modulators are attractive since they can be integrated with optical elements such as a semiconductor laser, an optical amplifier or electronic circuits such as FET and can be easily miniaturized and operated with a reduced voltage.

25 The semiconductor optical modulators include absorption-type optical modulators in which the intensity modulation is conducted by varying an optical absorption coefficient based on an effect that the absorption edge is shifted to a long-wave end by applying an electric field, e.g., a Franz-Keldish effect in bulk semiconductor or a quantum confined Stark effect in multi-quantum well (MQW), and Mach-Zehnder-type modulators which utilize a refractive index variation caused by an electrooptic effect (Pockels effect) or the quantum confined effect in bulk semiconductor.

30 In the Mach-Zehnder-type modulators, in principle, the chirping can be reduced to zero. However, since they have a interference-type structure, a simple linear waveguide structure as in the absorption-type modulators cannot be obtained, therefore its fabrication and operation are complicated. On the other hand, in the absorption-type modulators, the wavelength chirping is much lower than that of the semiconductor laser direct modulation manner, but it cannot be reduced to zero. In electroabsorption-type optical modulators, when an electric field corresponding to an electrical signal is applied to an optical absorption layer, the absorption coefficient for an incident light with a wavelength (λ_{op}) longer than the absorption-edge wavelength of the optical absorption layer of the modulator is increased to extinguish the incident light. FIG. 1 shows detuning $\Delta\lambda$ (a difference between the wavelength of an incident light and the absorption-edge wavelength of the optical absorption layer) and applied electric field dependencies of the absorption coefficient. By setting the detuning to be a proper value, a good extinction characteristic can be obtained. Thus, an external electrical signal can be converted into ON/OFF of light. In this case, the refractive index of the optical absorption layer to the incident light also varies as shown in FIG. 2. Namely, when the intensity of the electric field varies from zero to a value to conduct the absorption modulation, the refractive index of the optical absorption layer also varies. The magnitude of chirping when conducting ON/OFF of light is proportional to the ratio $\Delta n / \Delta\alpha$ of a refractive index variation Δn to an absorption variation $\Delta\alpha$. Therefore, since $\Delta n \geq 0$ and $\Delta\alpha \geq 0$ are usually obtained, a positive chirping occurs. However, if the difference between the wavelength of an incident light, λ_{op} and the absorption-edge wavelength of the optical absorption layer, λ_g , i.e., detuning $\Delta\lambda_{\text{op}} (= \lambda_{\text{op}} - \lambda_g)$ is decreased, $\Delta n \leq 0$ and $\Delta\alpha \geq 0$ can be satisfied, therefore allowing a negative chirping operation. But, since the absorption coefficient is increased, a sufficient light output cannot be obtained in the ON state of light. Recently, it has been experimentally proved that the chirping can be reduced by superposing a signal electric field corresponding to an electrical signal after applying a constant electric field to an electroabsorption-type optical modulator. Such an electroabsorption-type optical modulator has been expected to be a modulator for ultra-high speed and long distance optical communications in the future.

35 For example, such an electroabsorption-type optical modulator is reported in K. Yamada et al., "Low-Chirp, Low-Polarization Dependent Characteristics of Electroabsorption Optical Intensity Modulator with an InGaAsP Bulk", The Institute of Electronics Information and Information Engineers (IEICE), 1995 General Meeting, annex paper vol.1, p.349 (lecture No. C-349). In this report, it is described that the fiber dispersion durability in 10 Gb/s transmission and 1.55 μm wavelength can be enhanced by superposing an electrical signal after applying a constant bias to the modulator to overcome the dispersion limitation due to the transmission distance. Also, K. Morito et al., "10Gb/s Transmission over 100 km of Standard Fiber with a Blue Chirp", IEICE, 1995 Electronics Society Meeting, annex paper vol.1,

p.301(lecture No.C-301) reports an example of an electroabsorption optical modulator with a MQW structure, which is integrated with a DFB laser. In this report, it is described that the dispersion durability in 10Gb/s-100 km transmission can be enhanced by previously applying a constant bias of 1.1 V to the modulator.

As described above, the pre-bias applying techniques where a constant bias is previously applied to the electroabsorption-type optical modulator have merits that the chirping can be reduced and the limitation to the transmission distance due to the dispersion can be overcome. However, there occur problems that the emission power in the ON state of light is decreased and the extinction ratio is deteriorated when the pre-bias is applied. Furthermore, a drive circuit (bias T circuit) for applying a constant bias to an external electrical signal as shown in FIG.3 is required.

SUMMARY OF THE INVENTION

Accordingly, it is an object of the invention to provide an electroabsorption-type optical modulator in which a negative chirp during a modulation can be obtained without previously applying a constant bias and a sufficient light emission power and a good extinction ratio can be obtained.

It is a further object of the invention to provide a method for making such an electroabsorption-type optical modulator.

It is a still further object of the invention to provide an optical communication module which adopts such an electroabsorption-type optical modulator.

It is a still yet further object of the invention to provide an optical communication system which adopts such an electroabsorption-type optical modulator.

According to the invention, an electroabsorption-type optical modulator, comprises:

a semiconductor substrate; and

a semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer which are layered in this order on the semiconductor substrate;

wherein the absorption of a light wave supplied to an end of the semiconductor optical absorption layer is controlled by changing an intensity of electric field applied to the semiconductor optical absorption layer; and the semiconductor optical absorption layer has a region with absorption-edge wavelength shorter than that of the other region of the semiconductor optical absorption layer and a voltage corresponding an external electrical signal is simultaneously applied to both the regions of the semiconductor optical absorption layer, so that, to an incident light, a refractive index of the semiconductor optical absorption layer is decreased and an absorption coefficient of the semiconductor optical absorption layer is increased when an intensity of electric field applied to the semiconductor optical absorption layer corresponding to the external electrical signal is increased.

Also, according to the invention, an electroabsorption-type optical modulator, comprises:

a semiconductor substrate; and

a semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer which are layered in this order on the semiconductor substrate;

wherein the absorption of a light wave supplied to an end of the semiconductor optical absorption layer is controlled by changing an intensity of electric field applied to the semiconductor optical absorption layer; and the semiconductor optical absorption layer has absorption-edge wavelengths which continuously vary along the direction of waveguiding an incident light from a short-wave side to a long-wave side or from a long-wave side to a short-wave side, so that, to an incident light, a refractive index of the semiconductor optical absorption layer is decreased and an absorption coefficient of the semiconductor optical absorption layer is increased when an intensity of electric field applied to the semiconductor optical absorption layer corresponding to the external electrical signal is increased.

Also, according to the invention, an electroabsorption-type optical modulator, comprises:

a semiconductor substrate; and

a semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer which are layered in this order on the semiconductor substrate;

wherein the absorption of a light wave supplied to an end of the semiconductor optical absorption layer is controlled by changing an intensity of electric field applied to the semiconductor optical absorption layer; and the semiconductor optical absorption layer has absorption-edge wavelengths which vary stepwise along the direction of waveguiding an incident light, so that, to an incident light, a refractive index of the semiconductor optical absorption layer is decreased and an absorption coefficient of the semiconductor optical absorption layer is increased when an intensity of electric field applied to the semiconductor optical absorption layer corresponding to

the external electrical signal is increased.

According to another aspect of the invention, a method for making a semiconductor optical modulator, comprises the steps of:

5 forming a first semiconductor buffer layer on a semiconductor substrate;
 forming a first dielectric mask for selective growth on the first semiconductor buffer layer, the first dielectric mask including two regions in which a dielectric mask width is partially varied and a blank region sandwiched by the two regions;
 10 forming a second semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer in this order on the blank region;
 forming a second dielectric mask for selective growth which has a blank region broader than the blank region of the first dielectric mask;
 15 forming a semiconductor cladding layer and a semiconductor capping layer in this order on the blank region of the second dielectric mask for selective growth;
 forming a first dielectric protective film over the entire top surface of the substrate;
 forming a second dielectric protective film on the first dielectric protective film;
 removing the first dielectric protective film and the second dielectric protective film until the semiconductor capping layer is exposed;
 20 forming an electrode for applying an electric field to the semiconductor optical absorption layer on the semiconductor capping layer; and
 removing the second dielectric protective film except under the electrode;
 wherein the electrode on the semiconductor capping layer is formed all over the semiconductor optical absorption layer, so that a voltage corresponding to an external signal is uniformly applied to the semiconductor optical absorption layer.

According to a further aspect of the invention, an optical communication module, comprises:

the electroabsorption-type optical modulator defined above;
 30 a first light-condensing means for optically coupling an input light to the semiconductor optical absorption layer of the electroabsorption-type optical modulator; and
 a second light-condensing means for optically coupling a light output from the semiconductor optical absorption layer to an external optical fiber.

According to a further aspect of the invention, an optical communication system, comprises:

a transmitter which includes the electroabsorption-type optical modulator defined above;
 means for externally waveguiding a light output from the transmitter; and
 a receiver for receiving the light output from the waveguiding means.

40 In this invention, the semiconductor electroabsorption-type optical modulator has an optical absorption layer with a plurality of regions with different absorption-edge wavelengths along the direction of waveguiding a light, i.e., the optical absorption layer includes a region where a absorption-edge wavelength is shifted to a long-wave side rather than usual. Therefore, when a uniform electric field is applied to the regions, as the entire modulator, the refractive index is varied to a negative direction and the absorption coefficient is increased. Also, the ratio of lengths of the short-wave side and the long-wave side of the absorption layer is properly determined so that the absorption coefficient of the entire absorption layer is sufficiently small when no bias is applied. Thus, a negative chirp during a modulation can be obtained without previously applying a constant bias and a sufficient light emission power and a good extinction ratio can be obtained.

50 To provide such a structure, this invention employs a bandgap control technique using a selective MOVPE(metal organic vapor phase epitaxy) method. According as each of the widths of dielectric mask regions on both sides of the blank region is partially varied, the absorption-edge wavelength of the optical absorption layer is partially varied. By using the crystal growth method, the optical absorption layer with partially different absorption-edge wavelengths can be formed in one growth step, i.e., it is not necessary to repeat an etching and a crystal growth for divided regions.
 55 Therefore, an electroabsorption-type optical modulator can be made with a good uniformity, reproducibility and controllability.

BRIEF DESCRIPTION OF THE DRAWINGS

The invention will be explained in more detail in conjunction with the appended drawings, wherein:

- 5 FIG.1 shows the detuning and applied electric field dependencies of an absorption coefficient of the optical absorption layer in a conventional electroabsorption-type optical modulator,
 FIG.2 shows detuning and applied electric field dependencies of the refractive index of the optical absorption layer in a conventional electroabsorption-type optical modulator,
 FIG.3 is a block diagram showing a driving method in conventional electroabsorption-type optical modulators,
 10 FIG.4 is a perspective view showing a InP-system MQW electroabsorption-type optical modulator in a first preferred embodiment of the invention,
 FIGS.5A to 5H are cross sectional views showing a method for making the InP-system MQW electroabsorption-type optical modulator in the first embodiment,
 FIG.6 is a plan view showing an example of a first mask pattern for selective growth used to make the InP-system MQW electroabsorption-type optical modulator in the first embodiment,
 FIG.7 is a plan view showing an example of a second mask pattern for selective growth used to make the InP-system MQW electroabsorption-type optical modulator in the first embodiment,
 FIG.8 shows the detuning and applied electric field dependencies of an absorption coefficient of an optical absorption layer in the InP-system MQW electroabsorption-type optical modulator in the first embodiment,
 20 FIG.9 shows detuning and applied electric field dependencies of an refractive index of the optical absorption layer in the InP-system MQW electroabsorption-type optical modulator in the first embodiment,
 FIG.10 is a longitudinal sectional view cut along the line B-B' in FIG.4,
 FIG.11 is a perspective view showing a InP-system MQW electroabsorption-type optical modulator in a second preferred embodiment of the invention,
 25 FIGS.12A to 12H are cross sectional views showing a method for making the InP-system MQW electroabsorption-type optical modulator in the second embodiment,
 FIG.13 is a plan view showing an example of a first mask pattern for selective growth used to make the InP-system MQW electroabsorption-type optical modulator in the second embodiment,
 FIG.14 is a plan view showing an example of a second mask pattern for selective growth used to make the InP-system MQW electroabsorption-type optical modulator in the second embodiment,
 30 FIG.15 is a longitudinal sectional view cut along the line B-B' in FIG.11,
 FIG.16 is an illustration showing an optical communication module, which includes an electroabsorption-type optical modulator, in a third preferred embodiment of the invention, and
 FIG.17 is an illustration showing an optical communication system, which includes an optical communication module with an electroabsorption-type optical modulator, in a fourth preferred embodiment of the invention.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

40 A InP-system multiquantum well(MQW) electroabsorption-type optical modulator and a method for making the same in the first preferred embodiment will be explained in FIGS.4, 5A to 5H, 6, 7 and 10.

FIGS.5A to 5H show a method for making the InP-system multiquantum well(MQW) electroabsorption-type optical modulator, wherein FIGS.5A to 5H are cross sectional views cut along the line A-A' in FIG.4.

First, a n-InP buffer layer 102 with a thickness of 0.8 μm and a carrier concentration of $1 \times 10^{17} \text{ cm}^{-3}$ is formed on the entire surface of a (100) direction n-InP substance 101 (FIG.5A). Then, a SiO_2 film with a thickness of 1000 Å to provide a dielectric mask for selective growth is grown thereon, patterning the SiO_2 film by using a standard photolithography technique, thereby forming a first SiO_2 mask 201 for selective growth (FIG.5B). FIG.6 shows the pattern of the first SiO_2 mask 201 for selective growth which is seen from a position over the wafer. In a blank region 302 which is sandwiched between two regions of the SiO_2 mask 201, an absorption layer of the electroabsorption-type optical modulator is formed. In the blank region 302, the absorption layer for a long-wave side absorption-edge wavelength corresponding to the narrow-width area of the SiO_2 mask 201 and the absorption layer for a short-wave side absorption-edge wavelength corresponding to the broad-width area of the SiO_2 mask 201 are formed. Next, by using the selective MOVPE (metal organic vapor phase epitaxy) crystal growth method with the SiO_2 mask, a n-InP cladding layer 202 with a thickness of 700 Å and a carrier concentration of $1 \times 10^{17} \text{ cm}^{-3}$, a MQW optical absorption layer 203 (eighteen periods of InGaAsP (6nm)/ InGaAsP (5.8nm)) with a thickness of 2124 Å and a carrier concentration of $5 \times 10^{15} \text{ cm}^{-3}$ and a p-InP cladding layer 204 with a thickness of 1600 Å and a carrier concentration of $5 \times 10^{17} \text{ cm}^{-3}$ are formed in this order (FIG.5C). Then, a SiO_2 film is formed on the entire surface of the wafer, subsequently forming a second SiO_2 mask 205 for selective growth which is used to bury the optical absorption layer by the photolithography (FIG.5D). FIG.7 shows the pattern of the second SiO_2 mask 205 for selective growth which is seen from a position over the wafer. A blank region 209 between the second SiO_2 masks 205 for selective growth has a width broader than that of the first

SiO₂ mask 201 for selective growth. Then, by using the selective MOVPE crystal growth method with the second SiO₂ mask 205 for selective growth, a p-buried cladding layer 207 with a thickness of 1.6 μm and a carrier concentration of 5x10¹⁷ cm⁻³, a p-InGaAs capping layer 208 with a thickness of 0.25 μm and a carrier concentration of 1x10¹⁹ cm⁻³ are formed (FIG. 5E). Then, after forming a SiO₂ protective film 300 with a thickness of 1000 Å on the entire surface of the wafer, a polyimide film 301 with a thickness of 3 μm is formed thereon (FIG. 5F). Then, uniformly removing the polyimide film 301 and the SiO₂ protective film 300 until the p-InGaAs capping layer 208 is exposed, a p-electrode 401 of Cr/Au is formed (FIG. 5G). Then, the polyimide film 301 except under the p-electrode 401 is removed, and a n-electrode 402 of Cr/Au (FIG. 5H) is formed. Finally, cleaving the device, conducting a reflectionless coating on the end surfaces for the emission and incidence of light, the device fabrication is completed. FIG. 10 is a cross sectional view of the fabricated device cut along the line B-B' in FIG. 4. The absorption-edge wavelength λ_{g1} in region 1 is set to be longer than the absorption-edge wavelength λ_{g2} in region 2.

The operation of the InP-system MQW electroabsorption-type optical modulator fabricated by the above process will be explained below. A light wave with a wavelength of 1.55 μm supplied to the InP-system MQW electroabsorption-type optical modulator shown in FIG. 4 is emitted substantially without being absorbed when an external bias of 0V is applied to the modulator (light ON state), and it is absorbed to extinguish the light when an external bias of 2V is applied (light OFF state). In this regard, variations of the absorption coefficient and the refractive index in the long-wave and short-wave sides of the optical absorption layer of the electroabsorption-type optical modulator are shown in FIGS. 8 and 9. The electric field intensities of 0 kV/cm to 90 kV/cm correspond to the applied signal biases 0V to 2V, and the variation of refractive index Δn₁ is -0.013 to the short-wave side detuning (difference between the incident light wavelength and the absorption-edge wavelength of the optical absorption layer) Δλ₁=40 nm and the variation of refractive index Δn₂ is 0.0025 to the long-wave side detuning Δλ₂=70 nm. The waveguide length of the short-wave side optical absorption layer L₁ is 30 μm and the waveguide length of the long-wave side optical absorption layer L₂ is 150 μm. The phase variation Δφ of an incident light caused by the signal bias change from the OFF state to the ON state is given by:

$$\Delta\phi = \frac{2\pi}{\lambda} (L_1 \cdot \Delta n_1 + L_2 \cdot \Delta n_2) \leq 0 \quad (\lambda: \text{wavelength of incident light})$$

The parameter α that represents the chirping is given by:

$$\alpha = 2I \frac{\Delta I}{\Delta\phi}$$

where I represents an intensity of incident light and ΔI represents a variation of I. Thus, the electroabsorption-type optical modulator has a characteristic of α ≤ 0.

Though the absorption coefficient in the ON state (applied signal bias of 0V) is increased according as the detuning is shifted to the short-wave side, the absorption loss in the ON state can be suppressed to be substantially small since the waveguide length L₁ (=30 μm) of the optical absorption layer with the short-wave side detuning in the electroabsorption-type optical modulator is sufficiently short.

As explained above, in the first embodiment, the negative chirping modulation operation can be performed without previously applying a DC bias and without causing an increase in absorption loss.

Meanwhile, in the electroabsorption-type optical modulator shown in FIG. 4, since the polyimide film 301 is thick buried under the pad, the pad capacity can be reduced. Thus, by using the reduction technique of the electrode capacity, the electroabsorption-type optical modulator in the first embodiment can be used for such a high-speed modulation as 10 Gb/s.

The invention is not limited to the above embodiment, where the InP-system MQW structure electroabsorption-type optical modulator is used, and may employ a InGaAs/InP MQW or a Al-system MQW. Also, the invention is not limited to the device form, for example, the thicknesses and compositions of the respective layers (films) or the dimension of the waveguide, in the first embodiment.

A InP-system multiquantum well (MQW) electroabsorption-type optical modulator and a method for making the same in the second preferred embodiment will be explained in FIGS. 11, 12A to 12H and 13 to 15.

FIGS. 12A to 12H show a method for making the InP-system multiquantum well (MQW) electroabsorption-type optical modulator, wherein FIGS. 12A to 12H are cross sectional views cut along the line A-A' in FIG. 11.

First, a n-InP buffer layer 102 with a thickness of 0.8 μm and a carrier concentration of 1x10¹⁷ cm⁻³ is formed on the entire surface of a (100) direction n-InP substance 101 (FIG. 12A). Then, a SiO₂ film with a thickness of 1000 Å to provide a dielectric mask for selective growth is grown thereon, patterning the SiO₂ film by using a standard photolithography technique, thereby forming a first SiO₂ mask 501 for selective growth (FIG. 12B). FIG. 13 shows the pattern of the first SiO₂ mask 501 for selective growth which is seen from a position over the wafer. In a blank region 502 which is sandwiched between two regions of the SiO₂ mask 501, an absorption layer of the electroabsorption-type optical modulator is formed. In the region 502, on both sides of which the width of the SiO₂ mask 501 is decreased along the direc-

tion of waveguiding light, the absorption layer for a long-wave side absorption-edge wavelength corresponding to the narrow-width area of the SiO₂ mask 501 and the absorption layer for a short-wave side absorption-edge wavelength corresponding to the broad-width area of the SiO₂ mask 501 are formed. Next, by using the selective MOVPE crystal growth method with the SiO₂ mask, a n-InP cladding layer 202 with a thickness of 700 Å and a carrier concentration of $1 \times 10^{17} \text{ cm}^{-3}$, a MQW optical absorption layer 203 (eighteen periods of InGaAsP(6nm)/InGaAsP(5.8nm)) with a thickness of 2124 Å and a carrier concentration of $5 \times 10^{15} \text{ cm}^{-3}$ and a p-InP cladding layer 204 with a thickness of 1600 Å and a carrier concentration of $5 \times 10^{17} \text{ cm}^{-3}$ are formed in this order (FIG. 12C). Then, a SiO₂ film is formed on the entire surface of the wafer, subsequently forming a second SiO₂ mask 505 for selective growth which is used to bury the optical absorption layer by the photolithography (FIG. 12D). FIG. 14 shows the pattern of the second SiO₂ mask 505 for selective growth which is seen from a position over the wafer. A blank region 509 between the second SiO₂ masks 505 for selective growth has a width broader than that of the first SiO₂ mask 501 for selective growth. Then, by using the selective MOVPE crystal growth method with the second SiO₂ mask 505 for selective growth, a p-buried cladding layer 207 with a thickness of 1.6 μm and a carrier concentration of $5 \times 10^{17} \text{ cm}^{-3}$, a p-InGaAs capping layer 208 with a thickness of 0.25 μm and a carrier concentration of $1 \times 10^{19} \text{ cm}^{-3}$ are formed (FIG. 12E). Then, after forming a SiO₂ protective film 300 with a thickness of 1000 Å on the entire surface of the wafer, a polyimide film 301 with a thickness of 3 μm is formed thereon (FIG. 12F). Then, uniformly removing the polyimide film 301 and the SiO₂ protective film 300 until the p-InGaAs capping layer 208 is exposed, a p-electrode 401 of Cr/Au is formed (FIG. 12G). Then, the polyimide film 301 except under the p-electrode 401 is removed, and a n-electrode 402 of Cr/Au (FIG. 12H) is formed. Finally, cleaving the device, conducting a reflectionless coating on the end surfaces for the emission and incidence of light, the device fabrication is completed. FIG. 15 is a cross sectional view of the fabricated device cut along the line B-B' in FIG. 11. The absorption-edge wavelength λ_g is set to be gradually changed from the long-wave side to the short-wave side along the direction of waveguiding light. Therefore, a sudden change of the absorption-edge wavelength in the optical absorption layer can be relaxed and reflection of a light wave or a radiation loss due to mode mismatching inside the optical absorption layer can be reduced as well as performing a negative chirping operation without applying a pre-bias.

An optical communication module in the third preferred embodiment of the invention will be explained in FIG. 16. As shown, the modulator module 618 for optical communications comprises the semiconductor electroabsorption-type optical modulator 619 in the first or second embodiment on a sub-mount 617, spherical lenses 612, 612 and optical fibers 613, 613. By using the module 619, a high-speed transmission of optical signal with a low insertion loss and a low chirp can be performed.

An optical communication system for trunk line system in the fourth preferred embodiment of the invention, which adopts the modulator module 618 for optical communications, will be explained in FIG. 17. As shown, a transmitter includes a light source 621 for inputting a light to the modulator module 618 for optical communications and a drive system 622 for driving the modulator module 618 and the light source 621. The light from the light source 621 is converted into an optical signal by the modulator module 618 for optical communications, transmitted through an optical fiber 623, and detected by a light-receiving unit 625 of a receiver 624. By using the optical communication system in the fourth embodiment, a repeater-free optical transmission further than 100 km can be easily realized. This is because the signal deterioration caused by the dispersion in the optical fiber 623 can be significantly suppressed due to the occurrence of a negative direction chirping.

As described above, according to the invention, the electroabsorption-type optical modulator, in which the negative chirping modulation can be performed without applying a constant bias and without increasing an absorption loss in the ON state of light, can be obtained without requiring the complicated fabrication process and with a good yield. In the invention, when the optical absorption waveguide of the electroabsorption-type optical modulator is fabricated, it can be formed by patterning the thin dielectric film such as SiO₂ to provide a mask for the selective growth and conducting the selective crystal growth, without using any etching process of semiconductor.

Furthermore, to change the absorption-edge wavelength of the optical absorption layer in a specific region, the region needs only to be sandwiched with the SiO₂ mask. To finely pattern the thin dielectric film over the broad area with a good reproducibility is much easier than to etch a semiconductor up to an order of μm. Thus, by using the method of the invention, the electroabsorption-type optical modulator with partial different absorption-edge wavelengths can be produced with a good reproducibility.

Although the invention has been described with respect to specific embodiment for complete and clear disclosure, the appended claims are not to be thus limited but are to be construed as embodying all modification and alternative constructions that may be occurred to one skilled in the art which fairly fall within the basic teaching here is set forth.

Claims

1. An electroabsorption-type optical modulator, comprising:

a semiconductor substrate; and

a semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer

which are layered in this order on said semiconductor substrate;

wherein the absorption of a light wave supplied to an end of said semiconductor optical absorption layer is controlled by changing an intensity of electric field applied to said semiconductor optical absorption layer; and

5 said semiconductor optical absorption layer has a region with absorption-edge wavelength shorter than that of the other region of said semiconductor optical absorption layer and a voltage corresponding an external electrical signal is simultaneously applied to both said regions of said semiconductor optical absorption layer, so that, to an incident light, a refractive index of said semiconductor optical absorption layer is decreased and an absorption coefficient of said semiconductor optical absorption layer is increased when an intensity of electric field applied to said semiconductor optical absorption layer corresponding to said external electrical signal is increased.

2. An electroabsorption-type optical modulator, comprising:

15 a semiconductor substrate; and

a semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer which are layered in this order on said semiconductor substrate;

wherein the absorption of a light wave supplied to an end of said semiconductor optical absorption layer is controlled by changing an intensity of electric field applied to said semiconductor optical absorption layer; and

20 said semiconductor optical absorption layer has absorption-edge wavelengths which continuously vary along the direction of waveguiding an incident light from a short-wave side to a long-wave side or from a long-wave side to a short-wave side, so that, to an incident light, a refractive index of said semiconductor optical absorption layer is decreased and an absorption coefficient of said semiconductor optical absorption layer is increased when an intensity of electric field applied to said semiconductor optical absorption layer corresponding to said external electrical signal is increased.

3. An electroabsorption-type optical modulator, comprising:

30 a semiconductor substrate; and

a semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer which are layered in this order on said semiconductor substrate;

wherein the absorption of a light wave supplied to an end of said semiconductor optical absorption layer is controlled by changing an intensity of electric field applied to said semiconductor optical absorption layer; and

35 said semiconductor optical absorption layer has absorption-edge wavelengths which vary stepwise along the direction of waveguiding an incident light, so that, to an incident light, a refractive index of said semiconductor optical absorption layer is decreased and an absorption coefficient of said semiconductor optical absorption layer is increased when an intensity of electric field applied to said semiconductor optical absorption layer corresponding to said external electrical signal is increased.

4. An electroabsorption-type optical modulator, according to claim 1, wherein:

45 said semiconductor optical absorption layer is composed of a multiquantum well structure.

5. An electroabsorption-type optical modulator, according to claim 2, wherein:

said semiconductor optical absorption layer is composed of a multiquantum well structure.

50 6. An electroabsorption-type optical modulator, according to claim 3, wherein:

said semiconductor optical absorption layer is composed of a multiquantum well structure.

7. A method for making a semiconductor optical modulator, comprising the steps of:

55 forming a first semiconductor buffer layer on a semiconductor substrate;

forming a first dielectric mask for selective growth on said first semiconductor buffer layer, said first dielectric mask including two regions in which a dielectric mask width is partially varied and a blank region sandwiched by said two regions;

forming a second semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer in this order on said blank region;

forming a second dielectric mask for selective growth which has a blank region broader than said blank region of said first dielectric mask;

5 forming a semiconductor cladding layer and a semiconductor capping layer in this order on said blank region of said second dielectric mask for selective growth;

forming a first dielectric protective film over the entire top surface of said substrate;

forming a second dielectric protective film on said first dielectric protective film;

10 removing said first dielectric protective film and said second dielectric protective film until said semiconductor capping layer is exposed;

forming an electrode for applying an electric field to said semiconductor optical absorption layer on said semiconductor capping layer; and

removing said second dielectric protective film except under said electrode;

15 wherein said electrode on said semiconductor capping layer is formed all over said semiconductor optical absorption layer, so that a voltage corresponding to an external signal is uniformly applied to said semiconductor optical absorption layer.

8. A method for making a semiconductor optical modulator, according to claim 7, wherein:

20 said semiconductor optical absorption layer is composed of a multiquantum well structure.

9. An optical communication module, comprising:

25 said electroabsorption-type optical modulator defined by claim 1;
a first light-condensing means for optically coupling an input light to said semiconductor optical absorption layer of said electroabsorption-type optical modulator; and
a second light-condensing means for optically coupling a light output from said semiconductor optical absorption layer to an external optical fiber.

30 10. An optical communication module, comprising:

said electroabsorption-type optical modulator defined by claim 2;
a first light-condensing means for optically coupling an input light to said semiconductor optical absorption layer of said electroabsorption-type optical modulator; and
35 a second light-condensing means for optically coupling a light output from said semiconductor optical absorption layer to an external optical fiber.

11. An optical communication module, comprising:

40 said electroabsorption-type optical modulator defined by claim 3;
a first light-condensing means for optically coupling an input light to said semiconductor optical absorption layer of said electroabsorption-type optical modulator; and
a second light-condensing means for optically coupling a light output from said semiconductor optical absorption layer to an external optical fiber.

45 12. An optical communication system, comprising:

a transmitter which includes said electroabsorption-type optical modulator defined by claim 1;
means for externally waveguiding a light output from said transmitter; and
50 a receiver for receiving said light output from said waveguiding means.

13. An optical communication system, comprising:

55 a transmitter which includes said electroabsorption-type optical modulator defined by claim 2;
means for externally waveguiding a light output from said transmitter; and
a receiver for receiving said light output from said waveguiding means.

14. An optical communication system, comprising:

a transmitter which includes said electroabsorption-type optical modulator defined by claim 3;
means for externally waveguiding a light output from said transmitter; and
a receiver for receiving said light output from said waveguiding means.

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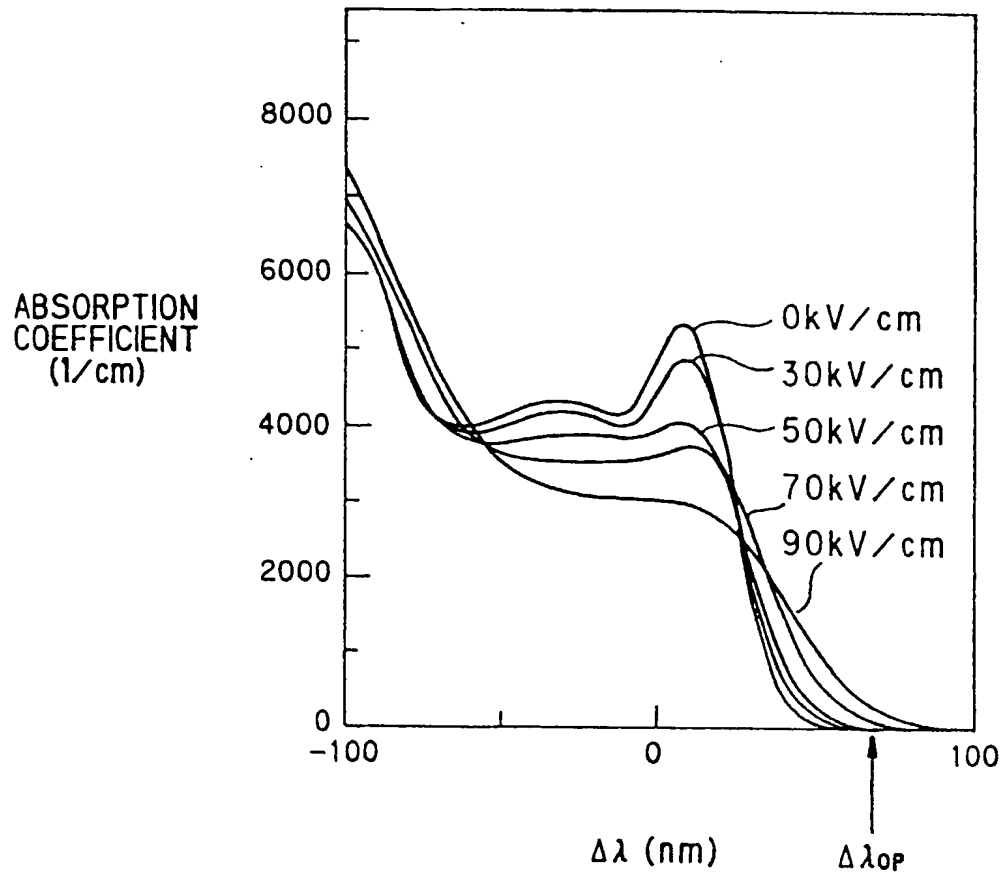
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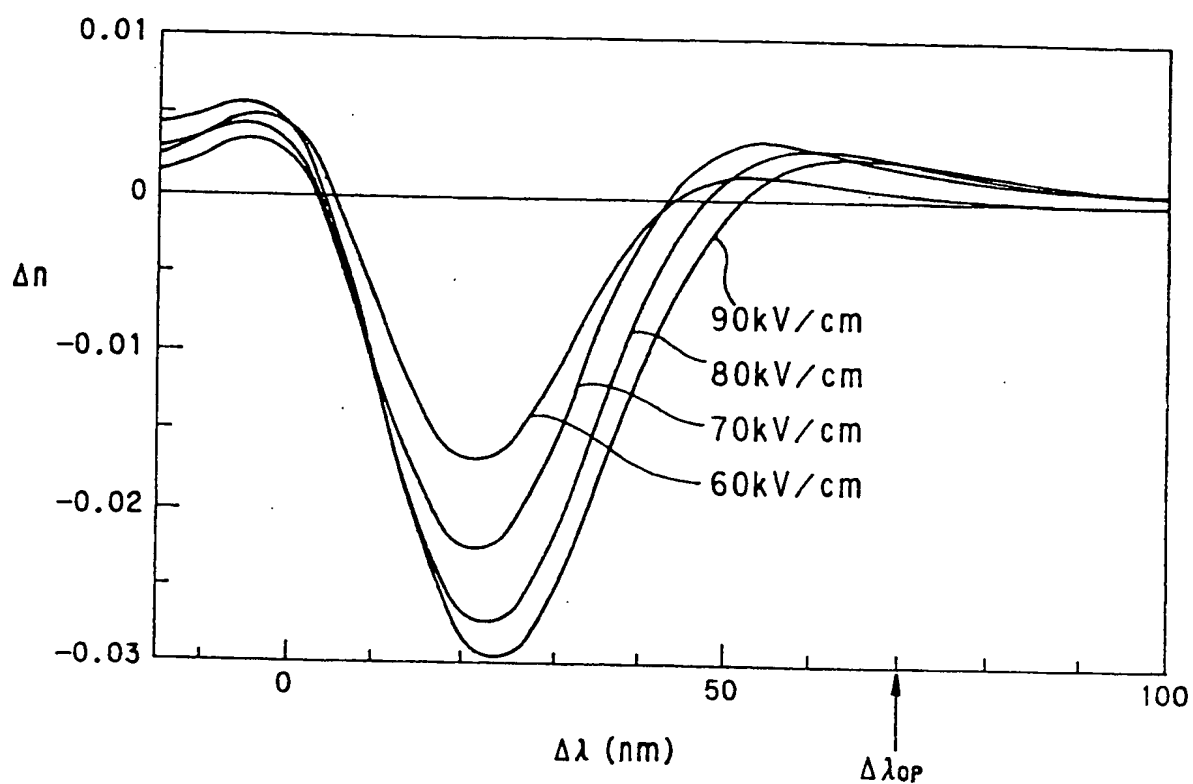
55

FIG. 1 PRIOR ART

$$\Delta\lambda_{OP} = \lambda_{OP} - \lambda_g$$

λ_g : ABSORPTION-EDGE WAVELENGTH
OF OPTICAL ABSORPTION LAYER

λ_{OP} : INCIDENT-LIGHT WAVELENGTH

FIG.2 PRIOR ART

λ_{OP} : INCIDENT-LIGHT WAVELENGTH

λ_g : ABSORPTION-EDGE WAVELENGTH
OF OPTICAL ABSORPTION LAYER

$$\Delta \lambda_{OP} = \lambda_{OP} - \lambda_g$$

FIG. 3 PRIOR ART

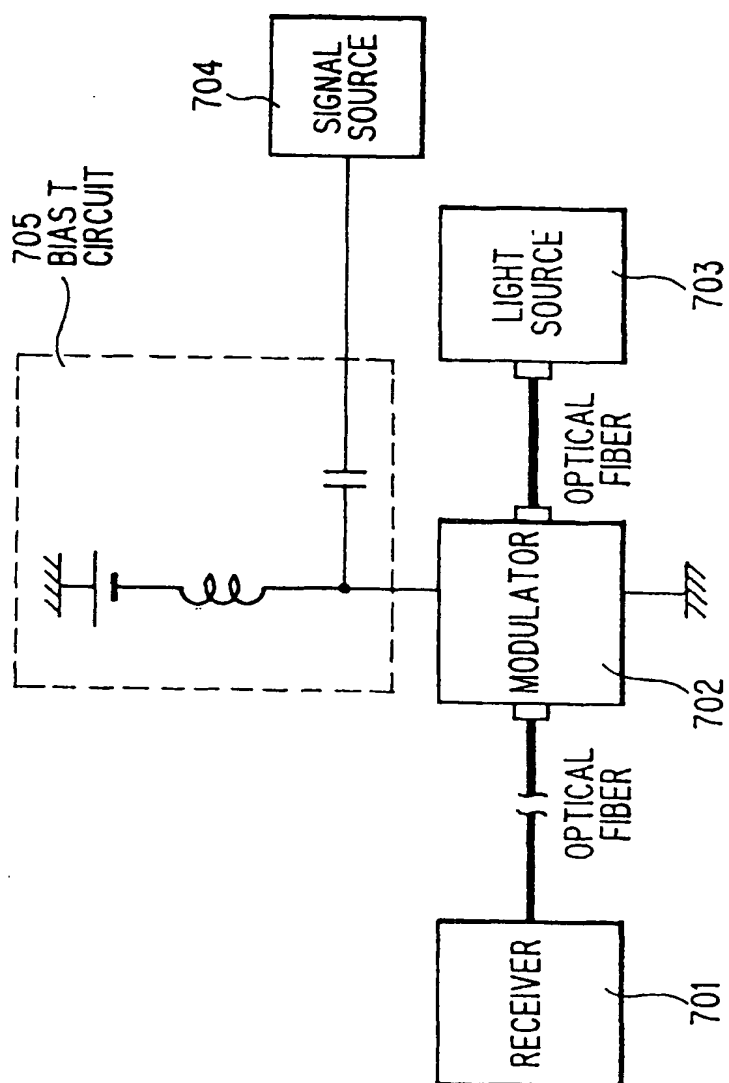


FIG. 4

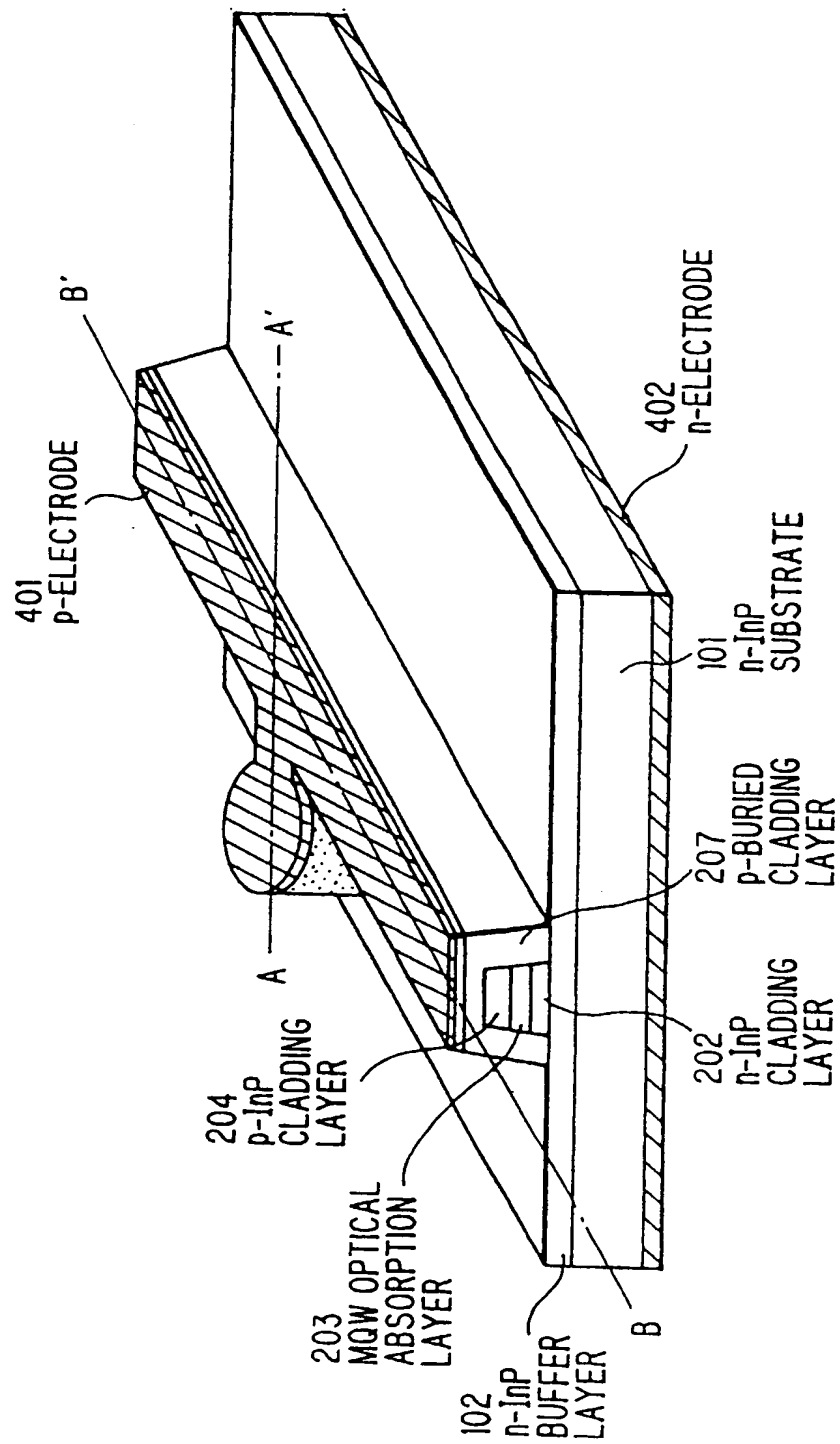


FIG. 5A

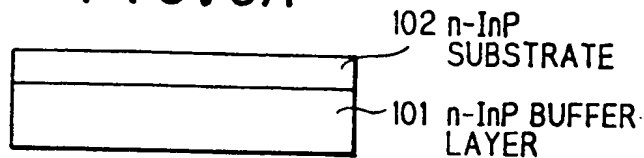


FIG. 5F

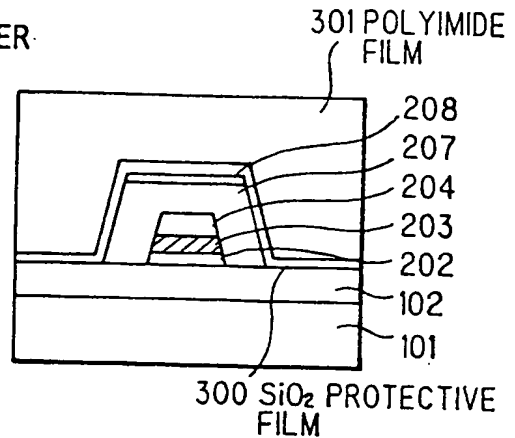


FIG. 5B

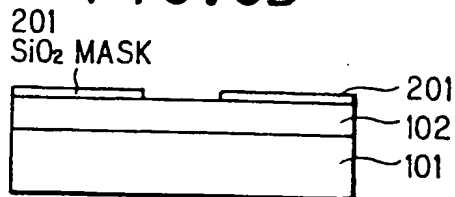


FIG. 5C

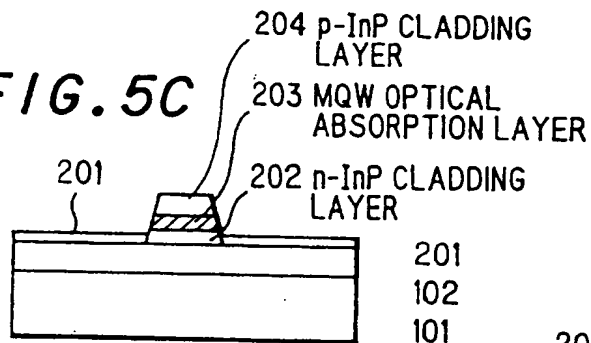


FIG. 5G

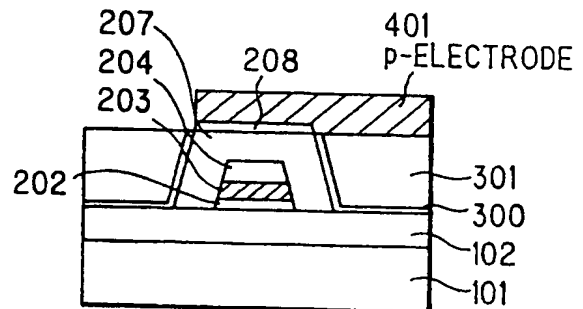


FIG. 5D

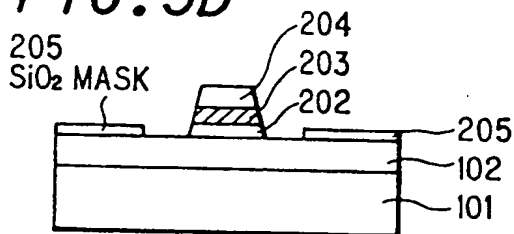


FIG. 5E

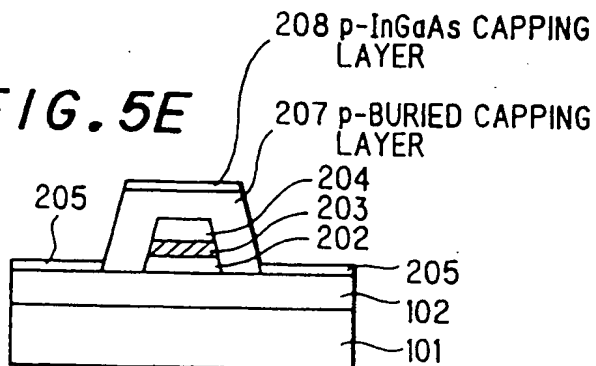


FIG. 5H

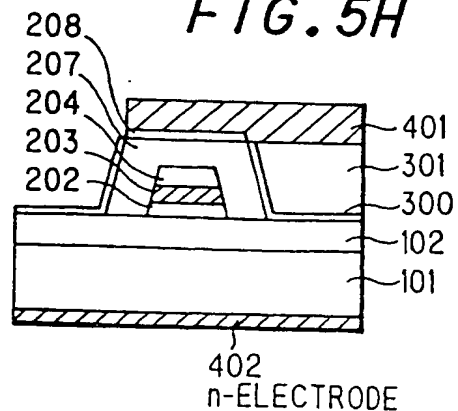


FIG. 6

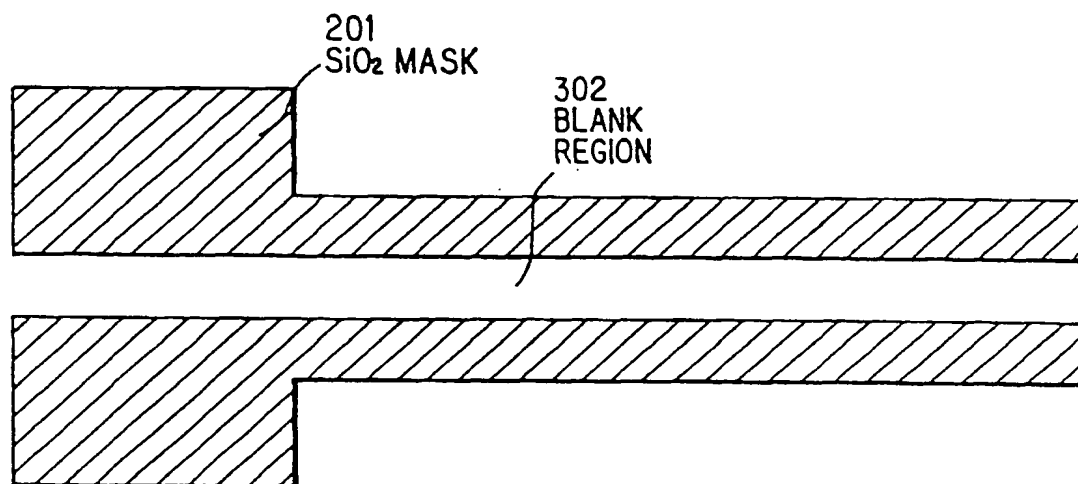


FIG. 7

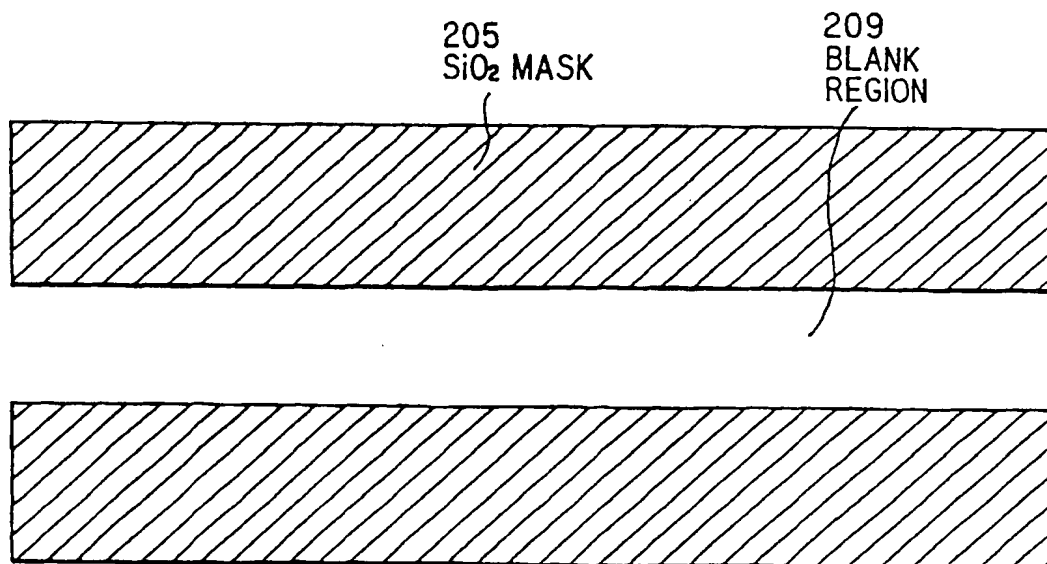


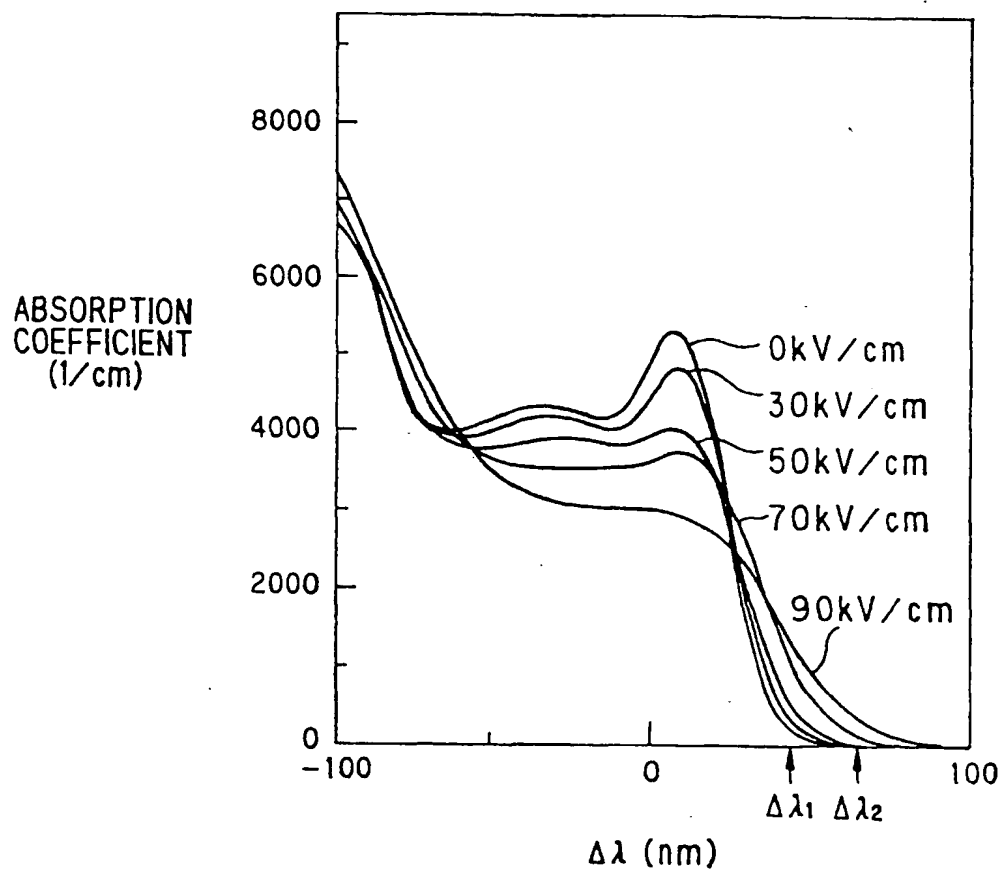
FIG. 8

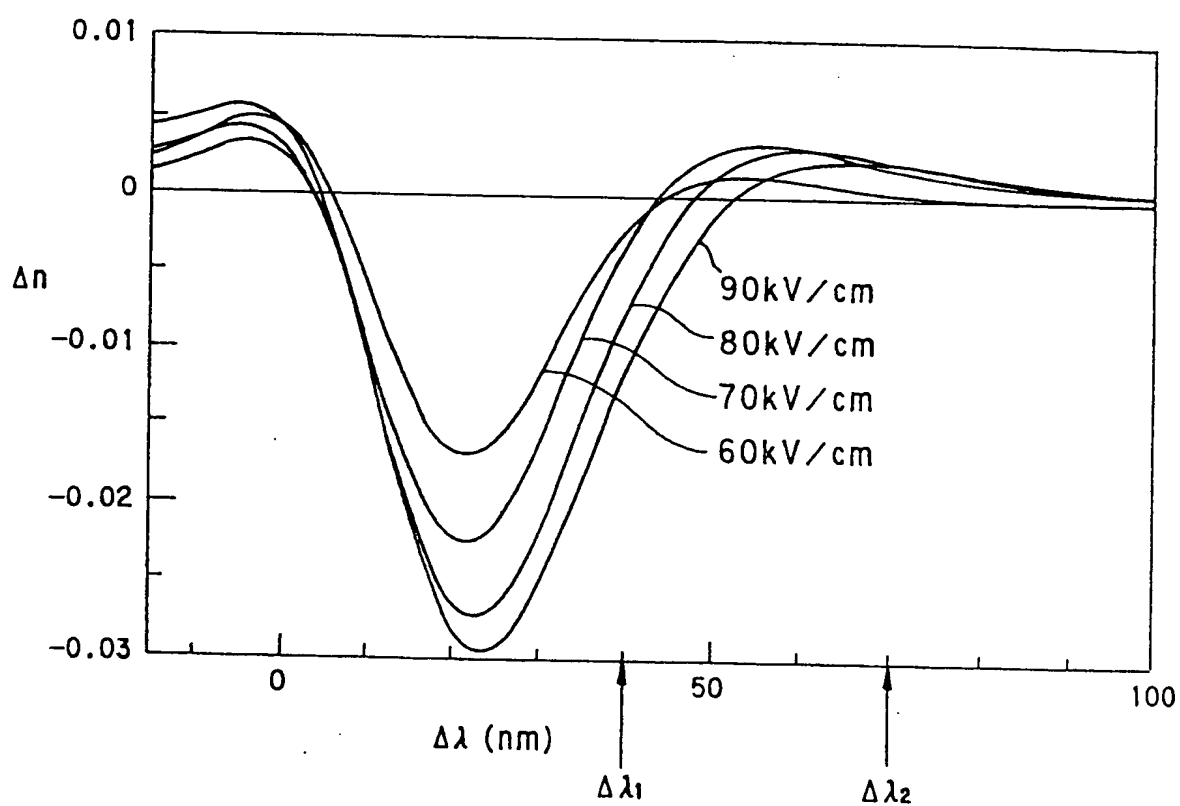
FIG. 9

FIG. 10

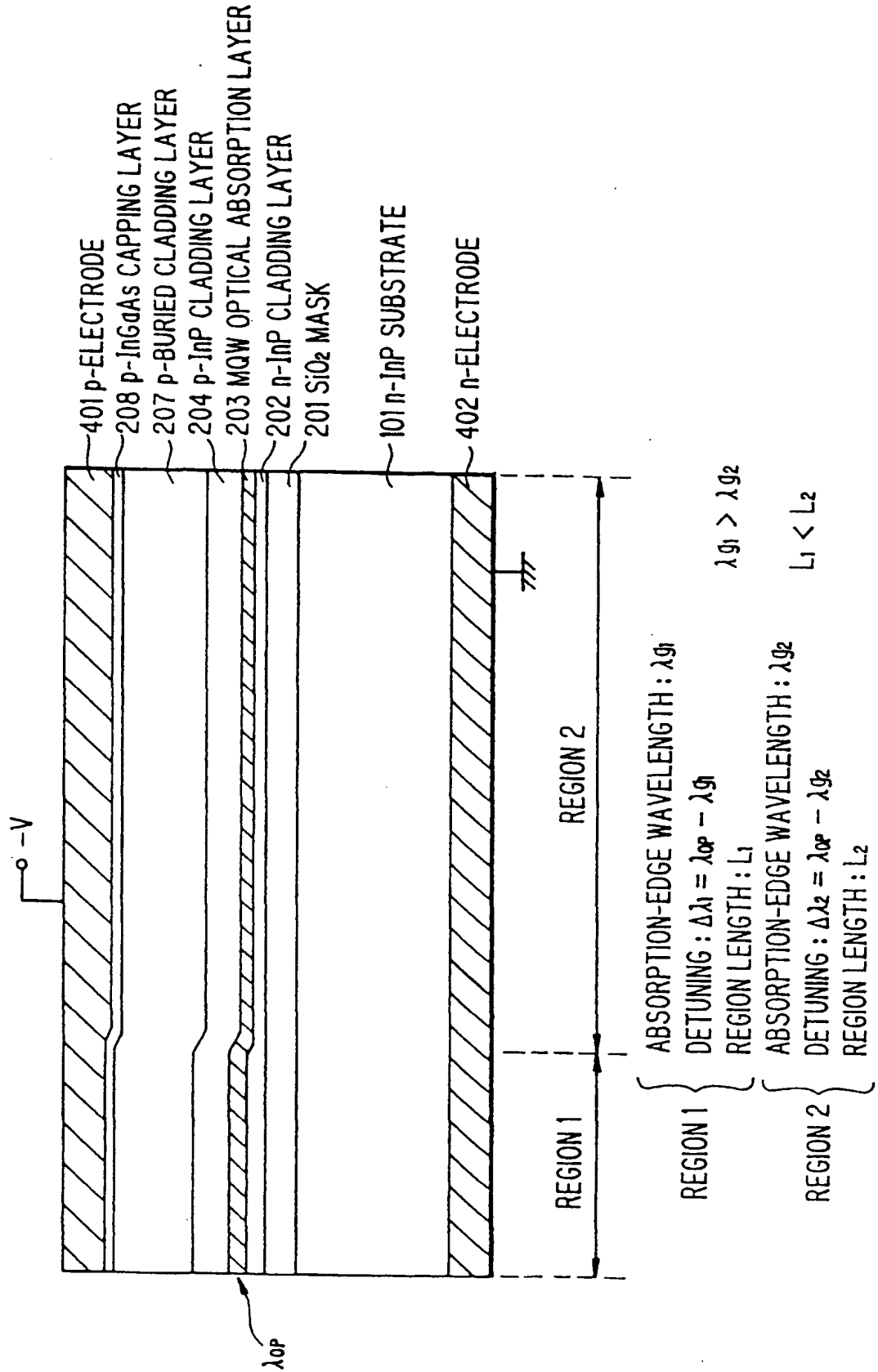


FIG. 11

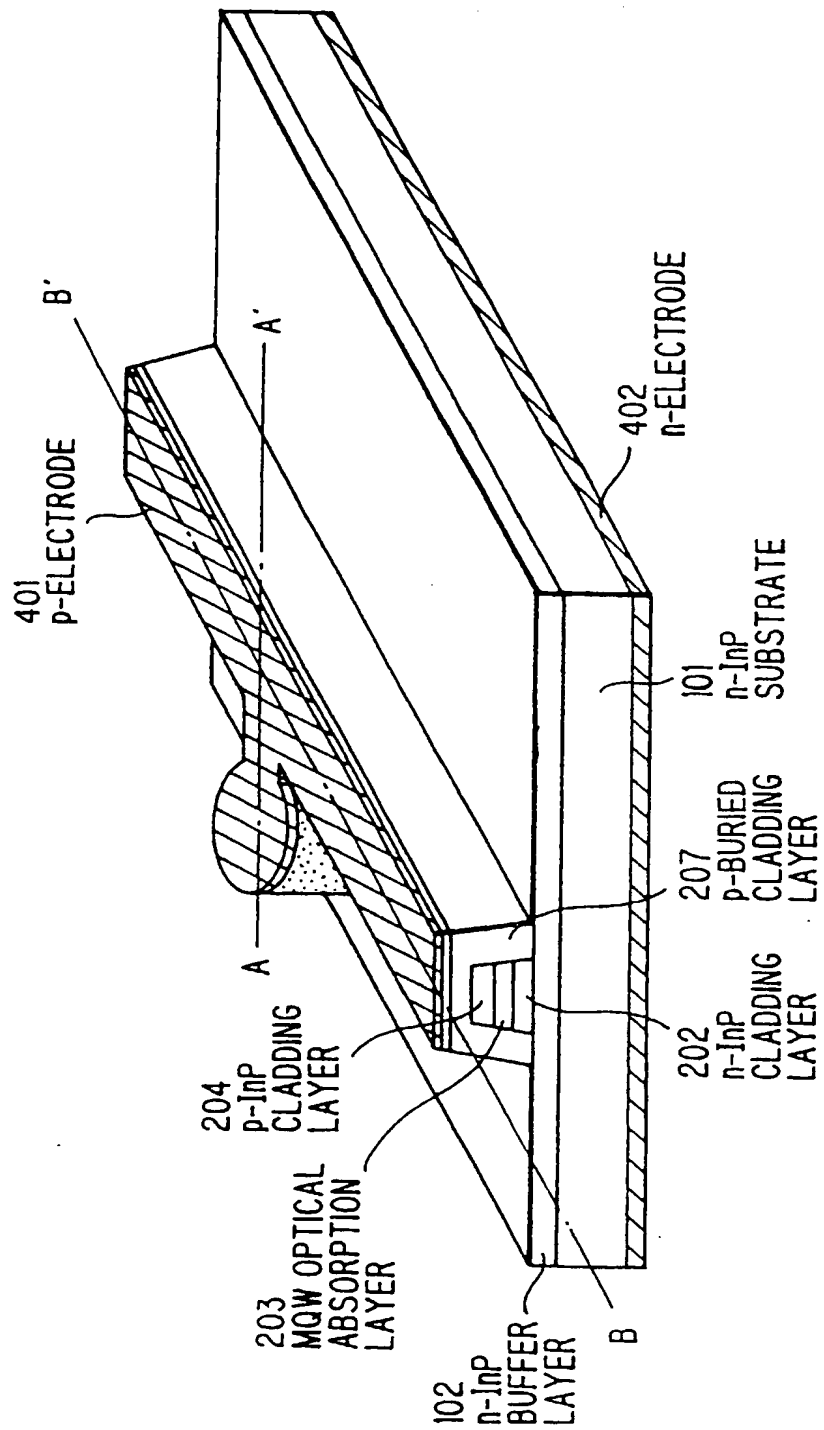


FIG. 12A

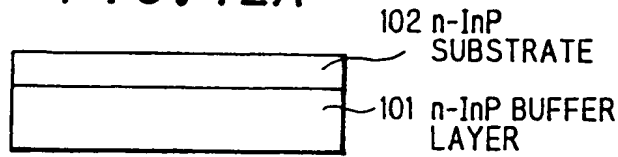


FIG. 12F

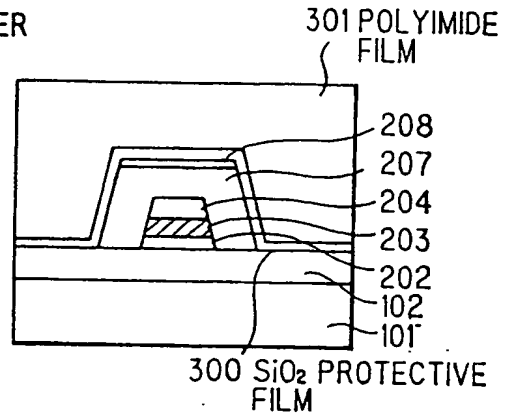


FIG. 12B

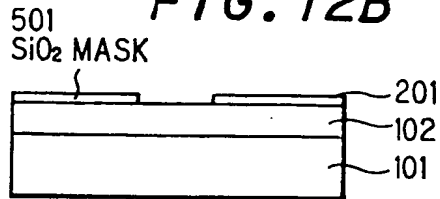


FIG. 12C

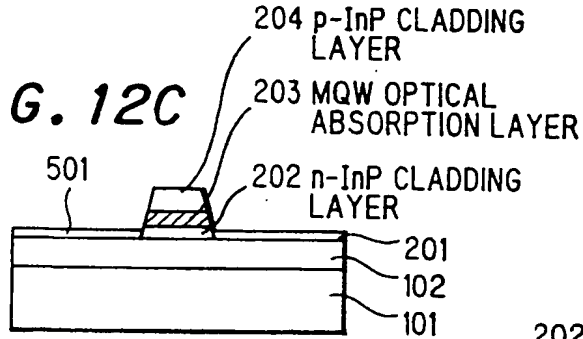


FIG. 12G

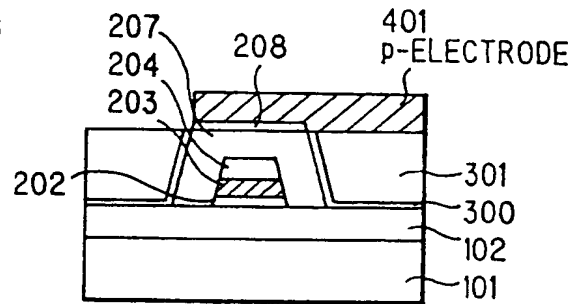


FIG. 12D

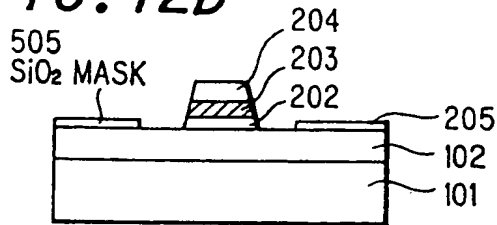


FIG. 12E

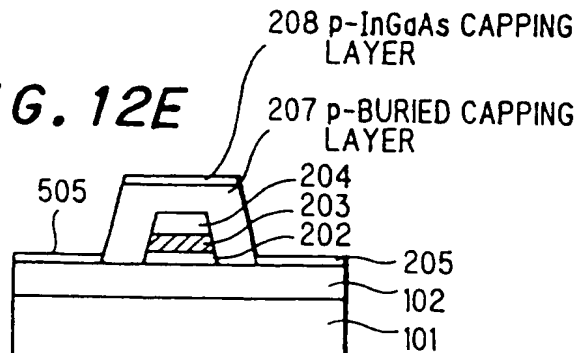


FIG. 12H

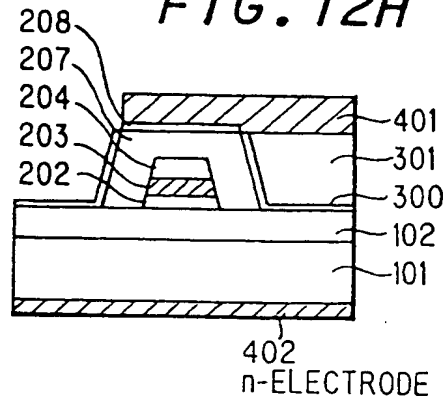


FIG. 13

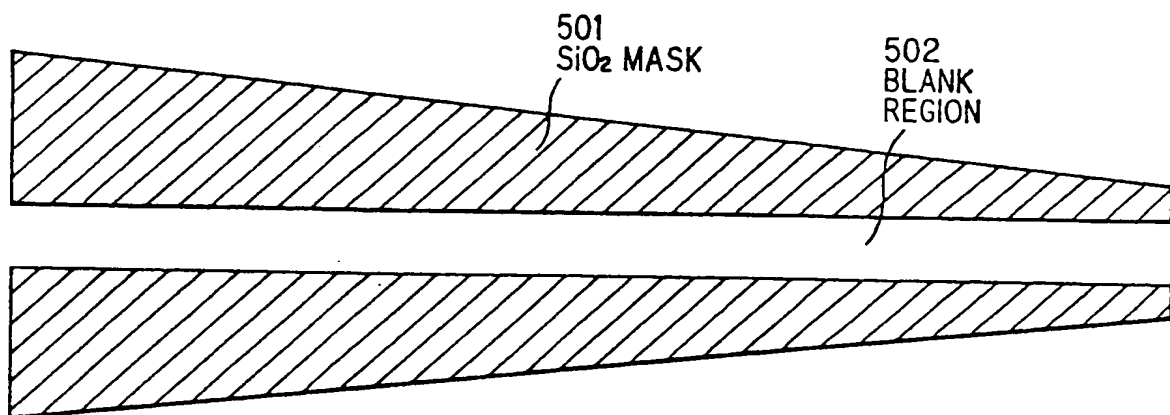


FIG. 14

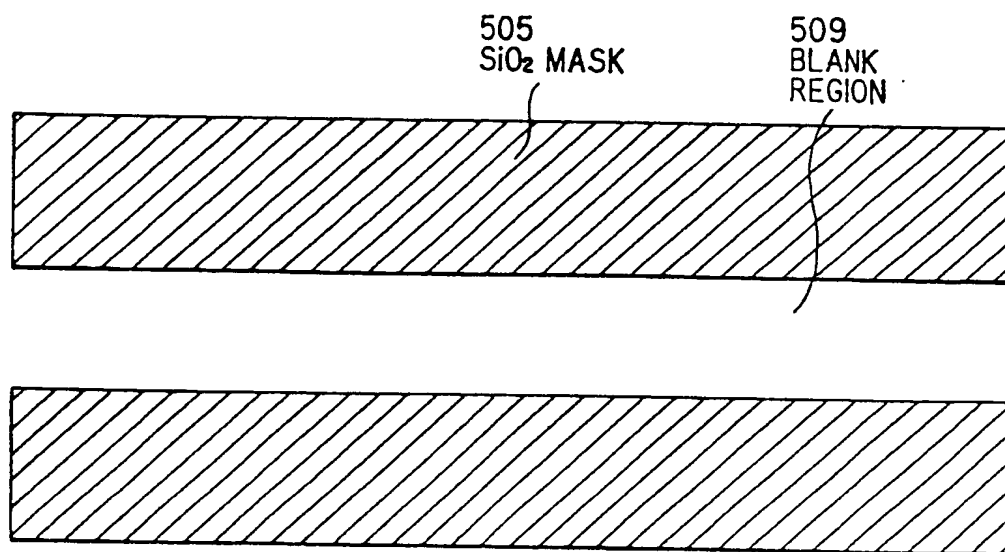


FIG. 15

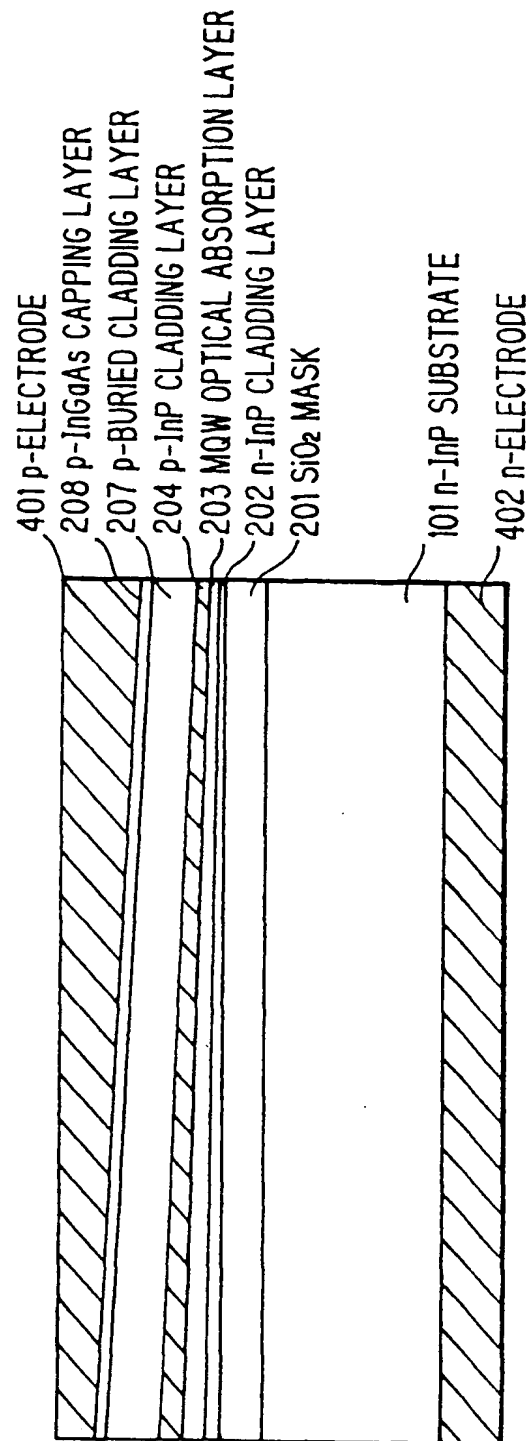
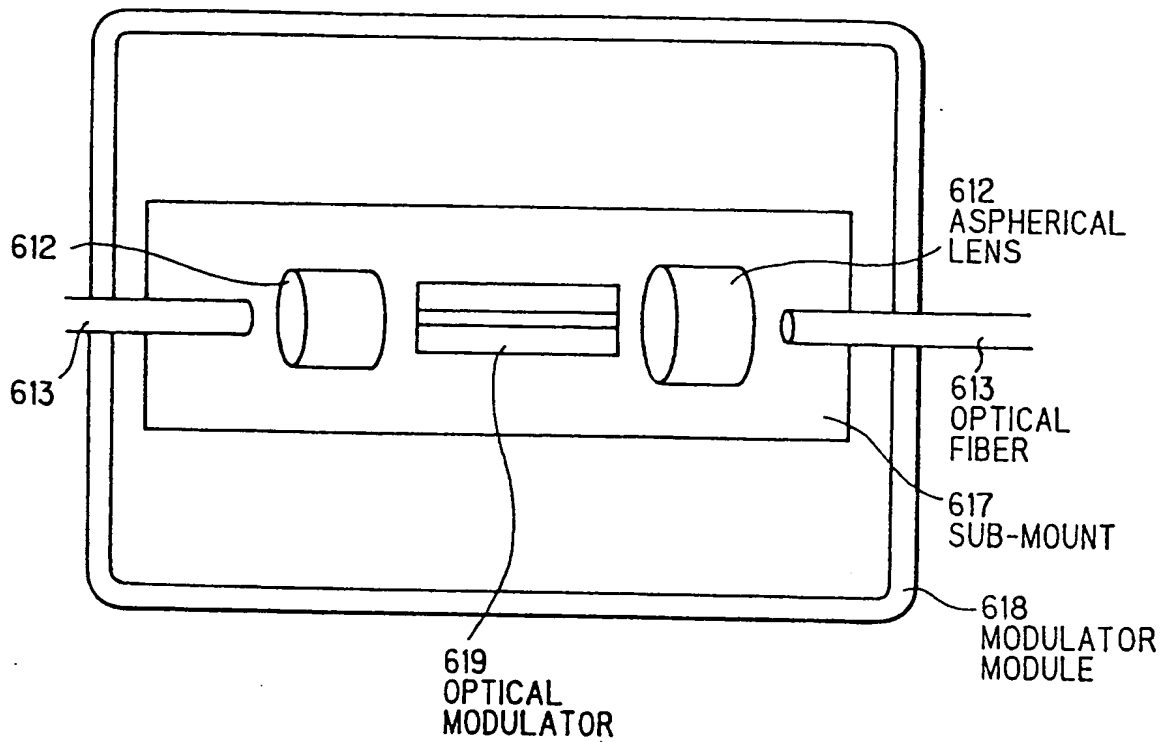
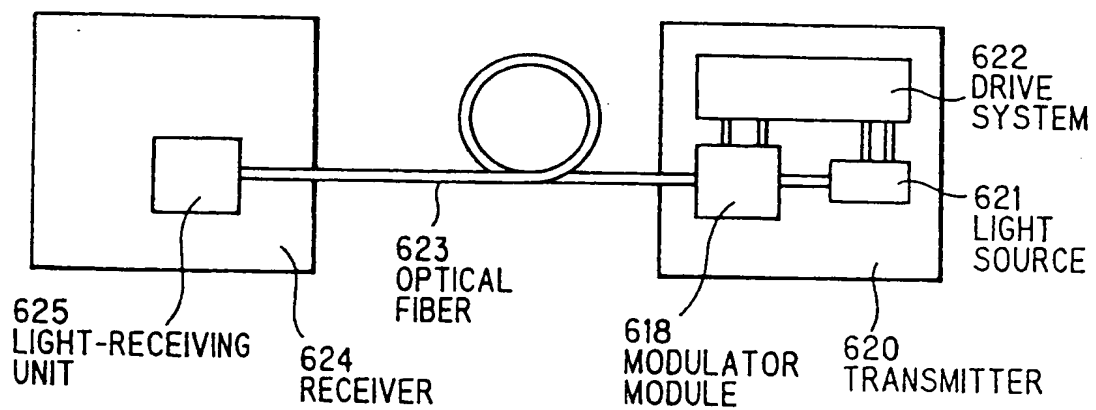


FIG. 16**FIG. 17**

(19)



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EP 0 809 129 A3

(12)

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(51) Int. Cl.⁶: G02F 1/015

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(71) Applicant: NEC CORPORATION
Tokyo (JP)

(72) Inventors:
• Ishizaka, Masashige
Minato-ku, Tokyo (JP)

• Yamazaki, Hiroyuki
Minato-ku, Tokyo (JP)

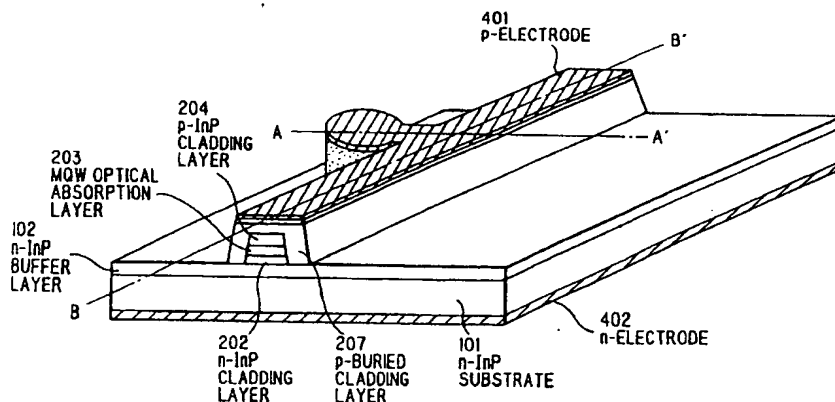
(74) Representative:
Glawe, Delfs, Moll & Partner
Patentanwälte
Postfach 26 01 62
80058 München (DE)

(54) Semiconductor optical modulator and method for making the same

(57) Disclosed is an electroabsorption-type optical modulator, which has: a semiconductor substrate; and a semiconductor buffer layer, a semiconductor optical absorption layer and a semiconductor cladding layer which are layered in this order on the semiconductor substrate; wherein the absorption of a light wave supplied to an end of the semiconductor optical absorption layer is controlled by changing an intensity of electric field applied to the semiconductor optical absorption layer; and the semiconductor optical absorption layer has a region with absorption-edge wavelength shorter than that of the other region of the semiconductor opti-

cal absorption layer and a voltage corresponding an external electrical signal is simultaneously applied to both the regions of the semiconductor optical absorption layer, so that, to an incident light, a refractive index of the semiconductor optical absorption layer is decreased and an absorption coefficient of the semiconductor optical absorption layer is increased when an intensity of electric field applied to the semiconductor optical absorption layer corresponding to the external electrical signal is increased.

FIG. 4



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EUROPEAN SEARCH REPORT

Application Number
EP 97 10 8311

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.6)
A	GB 2 243 456 A (HITACHI) * page 4, line 07 - line 22 * * page 12, line 9 - page 13, line 15 *	1-3	G02F1/015
A	CHEN Y ET AL: "QUANTUM WELL ELECTROABSORPTION MODULATORS AT 1.55 UM USING SINGLE-STEP SELECTIVE AREA CHEMICAL BEAM EPITAXIAL GROWTH" APPLIED PHYSICS LETTERS, vol. 61, no. 1, 6 July 1992, pages 10-12, XP000280638 * the whole document *	1-8	
A	EP 0 565 035 A (HITACHI) * column 3, line 17 - line 24 * * column 22, line 15 - column 23, line 10; figures 29A-C *	1-6	
A	KOMATSU K ET AL: "SEMICONDUCTOR EXTERNAL MODULATORS FOR 2.5 GB/S OPTICAL TRANSMISSION USING SELECTIVE GROWTH BY MOVPE" OPTOELECTRONICS DEVICES AND TECHNOLOGIES, vol. 9, no. 2, 1 June 1994, pages 241-250, XP000455305 * figures 2,5 *	9-14	TECHNICAL FIELDS SEARCHED (Int.Cl.6) G02F
A	PATENT ABSTRACTS OF JAPAN vol. 18, no. 518 (E-1612) & JP 06 181366 A (FUJITSU) * abstract *	1-3	
A	EP 0 703 476 A (NEC) * column 3, line 03 - column 6, line 57 * -/--	7	
The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 11 March 1998	Examiner Diot, P
<p>CATEGORY OF CITED DOCUMENTS</p> <p>X particularly relevant if taken alone Y particularly relevant if combined with another document of the same category A technological background O non-written disclosure P intermediate document</p> <p>T theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document</p>			

EPO FORM 1503 03/92 (P4/C01)



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EUROPEAN SEARCH REPORT

Application Number
EP 97 10 8311

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.6)
A	<p>FELLS J A J ET AL: "TRANSMISSION BEYOND THE DISPERSION LIMIT USING A NEGATIVE CHIRP ELECTROABSORPTION MODULATOR" ELECTRONICS LETTERS, vol. 30, no. 14, 7 July 1994, page 1168/1169 XP000461189</p> <p>* the whole document *</p> <p>-----</p>	1-6	
			TECHNICAL FIELDS SEARCHED (Int.Cl.6)
The present search report has been drawn up for all claims			
Place of search		Date of completion of the search	Examiner
THE HAGUE		11 March 1998	Diot, P
<p>CATEGORY OF CITED DOCUMENTS</p> <p>X : particularly relevant if taken alone</p> <p>Y : particularly relevant if combined with another document of the same category</p> <p>A : technological background</p> <p>O : non-written disclosure</p> <p>P : intermediate document</p> <p>T : theory or principle underlying the invention</p> <p>E : earlier patent document, but published on, or after the filing date</p> <p>D : document cited in the application</p> <p>L : document cited for other reasons</p> <p>& : member of the same patent family, corresponding document</p>			

FPO FORM 1503 03.82 (F04C01)